Document Number: GMAH1562-20C9 Preliminary Datasheet V1.0

1.5-6.2GHz, 20W, 28V GaN Fully matched PA Module

Description

The GMAH1562-20C9 is a 20-watt ,single stage integrated Power Amplifier Module, designed for broband applications, with frequencies from 1.5 to 6.2GHz. The module is 50 Ω input/output matched ϵ requires minimal external components. It can work at higher voltage like 32V with increased power capability



The module implements wideband power amplifier in form of multi chips, housed in cost effective plasuc open cavity package, offers a much lower cost than traditional MMIC solutions.

It is strongly recommended to solder this device directly onto the heatsink for CW operation, rather than grounding vias

Pout at 28V and fixed input power, CW

			<u> </u>			
Freq	Pin	Pout	Pout	IDS	Gain	Eff
(MHz)	(dBm)	(dBm)	(W)	(A)	(dB)	(%)
1500	37	43.68	23.3	2.05	6.67	40.6
2000	37	43.50	22.4	2.59	6.50	31.0
2500	37	44.18	26.2	2.23	7.18	42.0
3000	37	44.80	30.2	2.56	7.80	42.2
3500	37	44.99	31.6	3.02	7.99	37.3
4000	37	44.57	28.6	3.02	7.57	33.9
4500	37	44.38	27.4	2.60	7.38	37.7
5000	37	44.57	28.6	2.45	7.57	41.8
5500	37	44.69	29.4	2.36	7.69	44.6
6200	37	44.49	28.1	2.58	7.49	38.9

Psat across the full band at different input power referred to later pages, 32V data upon request

Product Features

• Operating Frequency Range: 1.5-6.2GHz

• Operating Drain Voltage: +28 V

• 50 Ω Input/Output

Psat≥43 dBm

• Minimum efficiency:>30%

• 12x10 mm Surface Mount Package

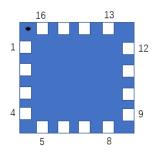
• Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

Applications

- Ultra Broadband Amplifiers
- Fiber Drivers
- Test Instrumentation
- EMC Amplifier Drivers
- 2-way Radios

Document Number: GMAH1562-20C9 Preliminary Datasheet V1.0

Pin Configuration and Description (Top view)



Pin No.	Symbol	Description
1	RF IN	RF Input
Input ISO Connect Input iso resistor(500hm) to GND directly		Connect Input iso resistor(500hm) to GND directly
4	Port	
9	RF OUT	RF Output
12	Output ISO	Series connection of isolation resistance (50 Ohm) and DC blocking capacitor(1000pF) to
12	Port	GND
6,15	Vgs	Gate bias
7,14	Vdd	Drain bias
Others	NC	No connection
Package Base	GND	DC/RF Ground. Proposed to be soldered to heatsink plane directly for the best CW
Fackage base		thermal and RF performance.

Table 1. Maximum Ratings

<u> </u>			
Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	150	Vdc
GateSource Voltage	V_{GS}	-10 to +2	Vdc
Operating Voltage	V _{DD}	+32	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Do 10	2.7	°C/W
T _C = 25°C, DC test, soldered on heatsink directly	Rejc	2.1	-C/VV

Table 3. Electrical Characteristics when production test

Parameter	Condition	Min	Тур	Max	Unit
Frequency Range		1500		6200	MHz
Power Gain @ Psat		9			dB
P _{SAT}	Pulse		43		dBm
Drain Efficiency @ P _{SAT}		30			%
Unless otherwise noted: TA = 25°C, Vpp =28 V, Pulse Width=50 us, Duty cycle=20%					

Load Mismatch of per Section (On Test Fixture, 50 ohm system): V_{DD} =28 V, I_{DQ} =25 mA, f = 3.5 GHz

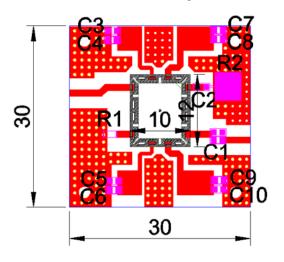
VSWR 10:1 at Psat pulse CW Output Power	No Device Degradation
---	-----------------------

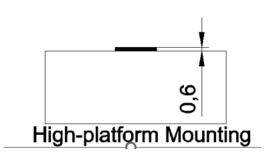


Document Number: GMAH1562-20C9 Preliminary Datasheet V1.0

Reference Circuit of Test Fixture Assembly Diagram

Figure 1. Test Circuit Component Layout





Component	Description	Suggestion
C1 C4 C5 C8 C9	8.2 pF	MQ400805
		BEIJING YUANLU HONGYUAN ELECTRONICTECHNOLOGYCO., LTD
C2 C3 C6 C7 C10	1uF	0805
R1	100 Ohm x 2 Parallel	1206
R2	50 Ohm	RFR 50-60
РСВ	20Mil Rogers 4350	

TYPICAL CHARACTERISTICS

Figure 2. Network analyzer output S11/S21 (Pin=0dBm)

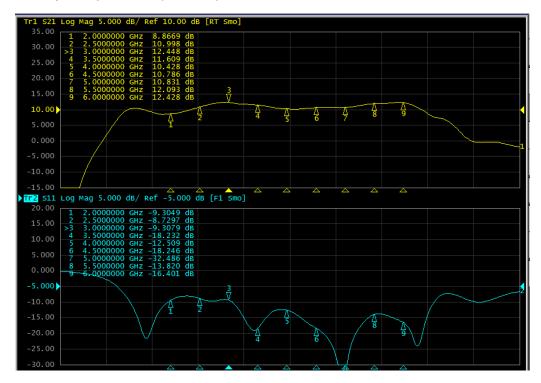
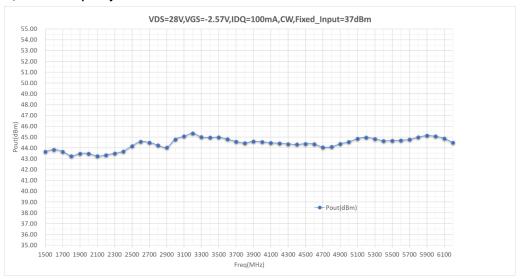
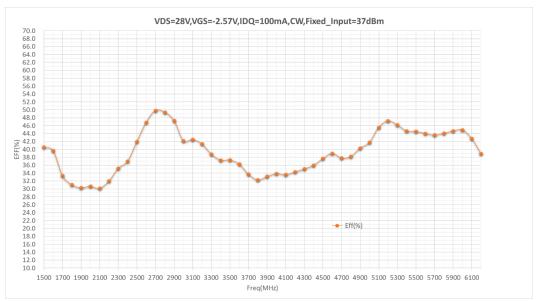




Figure 3. Pout, Eff, Gain Vs Frequency When fixed Pin @28V





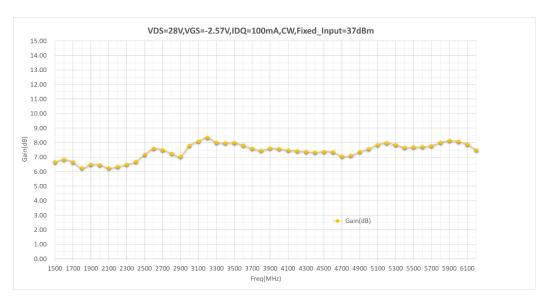
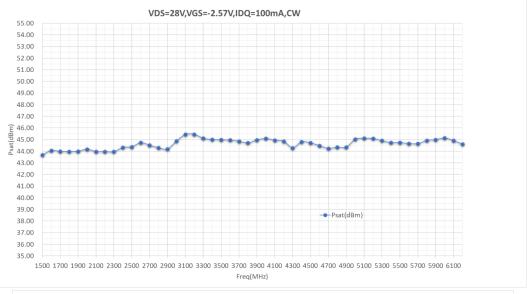
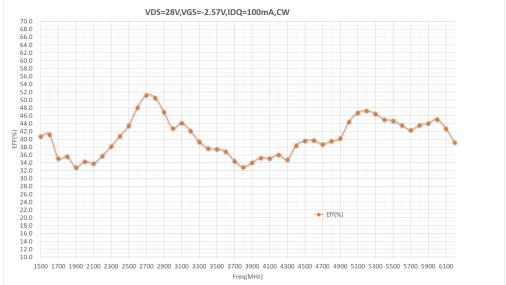


Figure 4. Psat Eff, Gain Vs frequency across the band @28V

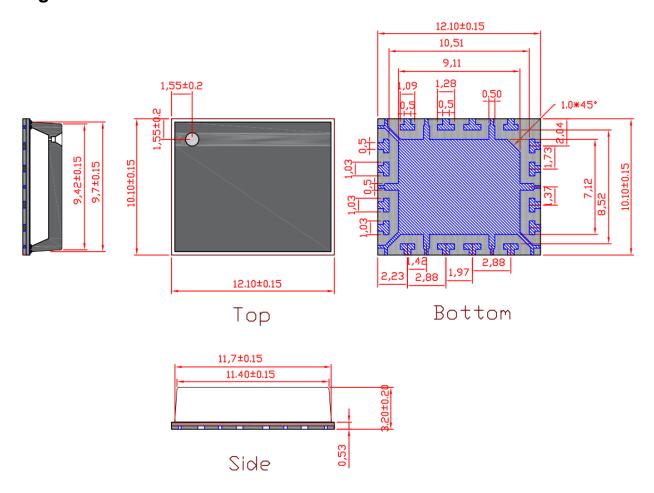








Package Dimensions (Unit:mm)



Revision history

Table 6. Document revision history

	1	
Date	Revision	Datasheet Status
2024/12/25	Rev 1.0	Preliminary Datasheet

Application data based on JF-24-17

Disclaimers

Specifications are subject to change without notice. Innogration believes the information contained within this data sheet to be accurate and reliable. However, no responsibility is assumed by Innogration for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Innogration . Innogration makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose. "Typical" parameters are the average values expected by Innogration in large quantities and are provided for information purposes only. These values can and do vary in different applications and actual performance can vary over time. All operating parameters should be validated by customer's technical experts for each application. Innogration products are not designed, intended or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Innogration product could result in personal injury or death or in applications for planning, construction, maintenance or direct operation of a nuclear facility. For any concerns or questions related to terms or conditions, pls check with Innogration and authorized distributors Copyright © by Innogration (Suzhou) Co.,Ltd.